

## General Description

This N-Channel 2.5V specified MOSFET is has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

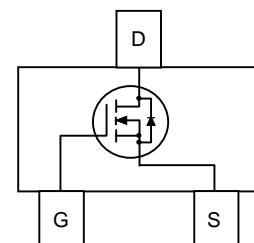
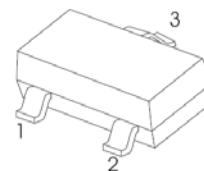
## Applications

- DC/DC converter
- Load switch

## Features

- $V_{DS} (V) = 20V$
- $R_{DS(ON)} < 38m\Omega$  ( $V_{GS} = 4.5V$ )
- $R_{DS(ON)} < 50m\Omega$  ( $V_{GS} = 2.5V$ )

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## Absolute Maximum Ratings $T_A = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DSS}$	Drain-Source Voltage	20	V
$V_{GSS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Drain Current - Continuous - Pulsed	3 20	A
$P_D$	Power Dissipation for Single Operation	0.5 0.46	W
	(Note 1a) (Note 1b)		
$T_J, T_{stg}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

## Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	250	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	75	$^\circ C/W$

**Electrical Characteristics** $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$		14		$\text{mV}/^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	$\mu\text{A}$
$I_{\text{GSSF}}$	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 8 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			100	nA
$I_{\text{GSSR}}$	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -8 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA
<b>On Characteristics</b> (Note 2)						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	0.4	0.85	1.5	V
$\frac{\Delta V_{\text{GS}(\text{th})}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$		-3		$\text{mV}/^\circ\text{C}$
$R_{\text{DS}(\text{on})}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 4.5 \text{ V}, I_D = 3 \text{ A}$		29	38	$\text{m}\Omega$
		$V_{\text{GS}} = 2.5 \text{ V}, I_D = 2.4 \text{ A}$		39	50	
$I_{\text{D}(\text{on})}$	On-State Drain Current	$V_{\text{GS}} = 4.5 \text{ V}, V_{\text{DS}} = 5 \text{ V}$	10			A
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 5 \text{ V}, I_D = 3 \text{ A}$		11		S
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 10 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$		700		pF
$C_{\text{oss}}$	Output Capacitance			175		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			85		pF
<b>Switching Characteristics</b> (Note 2)						
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}} = 10 \text{ V}, I_D = 1 \text{ A}, V_{\text{GS}} = 4.5 \text{ V}, R_{\text{GEN}} = 6 \Omega$		8	16	ns
$t_r$	Turn-On Rise Time			10	18	ns
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time			18	29	ns
$t_f$	Turn-Off Fall Time			5	10	ns
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 10 \text{ V}, I_D = 3 \text{ A}, V_{\text{GS}} = 4.5 \text{ V}$		7	10	nC
$Q_{\text{gs}}$	Gate-Source Charge			1.2		nC
$Q_{\text{gd}}$	Gate-Drain Charge			1.9		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain-Source Diode Forward Current				0.42	A
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_s = 0.42 \text{ A}$ (Note 2)		0.65	1.2	V

## Notes:

1:  $R_{\text{thJA}}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\text{thJC}}$  is guaranteed by design while  $R_{\text{thCA}}$  is determined by the user's board design.



a) 250°C/W when mounted on a 0.02 in<sup>2</sup> Pad of 2 oz. Cu.

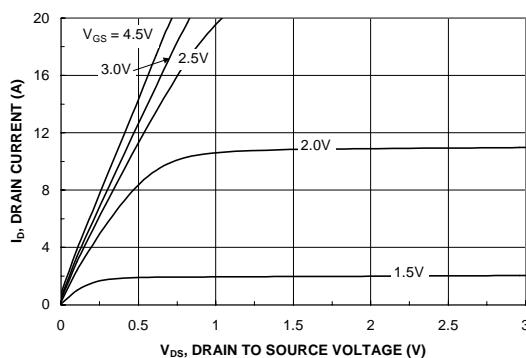


b) 270°C/W on a minimum mounting pad of 2 oz. Cu.

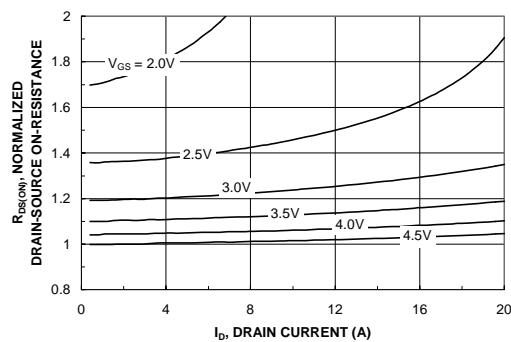
Scale 1 : 1 on letter size paper

2: Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%

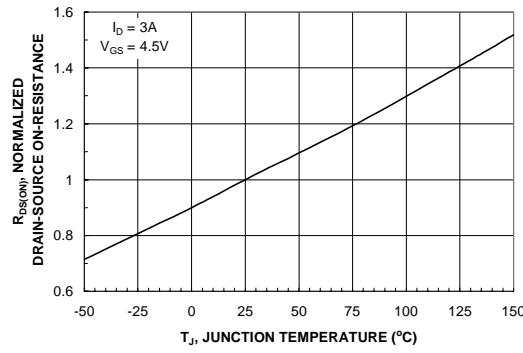
## Typical Characteristics



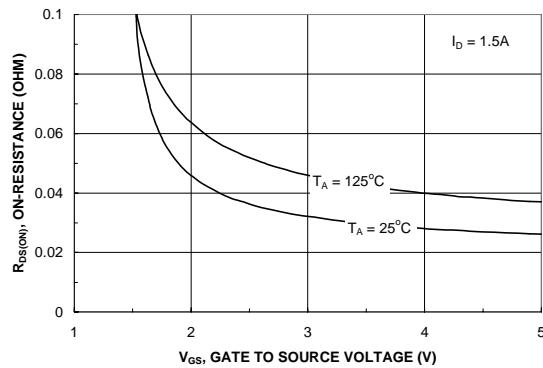
**Figure 1. On-Region Characteristics.**



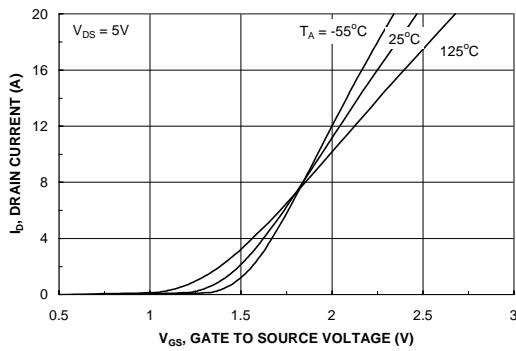
**Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.**



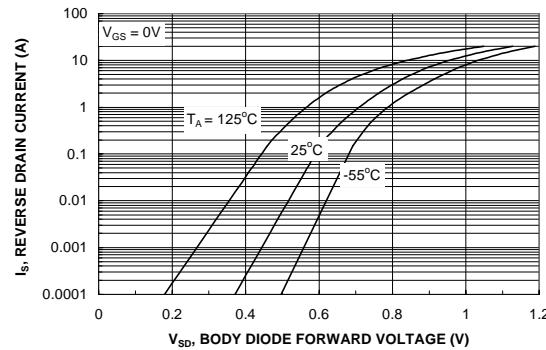
**Figure 3. On-Resistance Variation with Temperature.**



**Figure 4. On-Resistance Variation with Gate-to-Source Voltage.**



**Figure 5. Transfer Characteristics.**



**Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.**

## Typical Characteristics (continued)

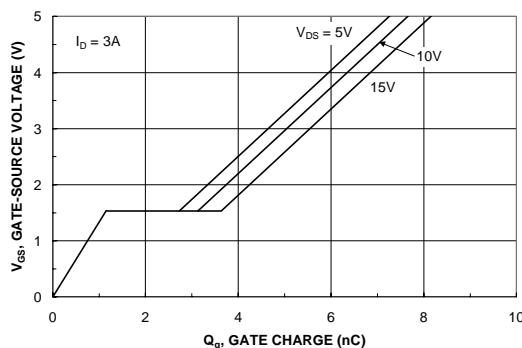


Figure 7. Gate Charge Characteristics.

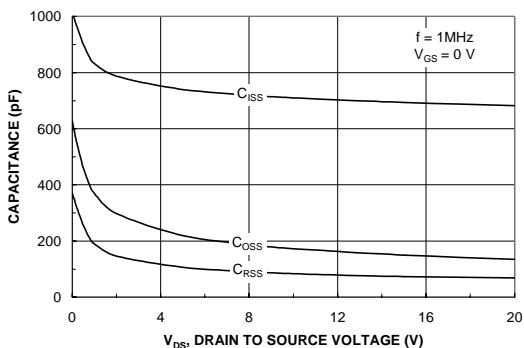


Figure 8. Capacitance Characteristics.

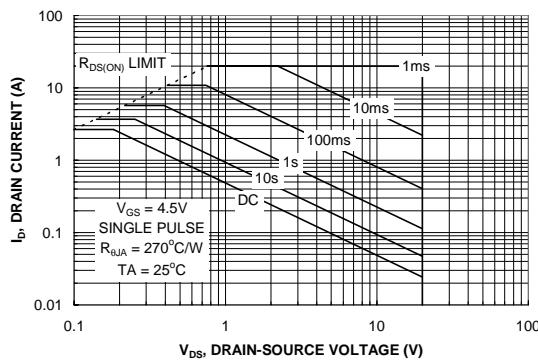


Figure 9. Maximum Safe Operating Area.

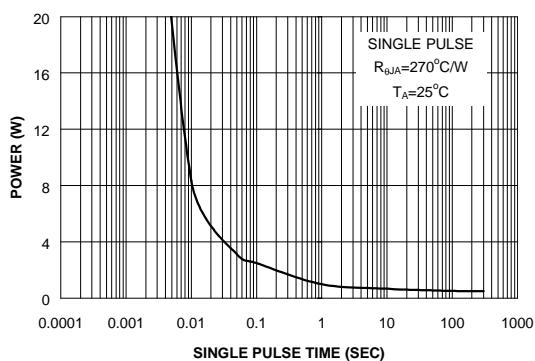


Figure 10. Single Pulse Maximum Power Dissipation.

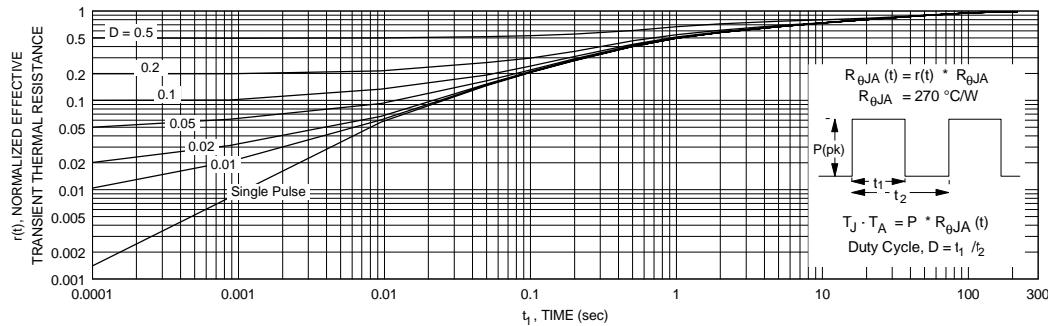
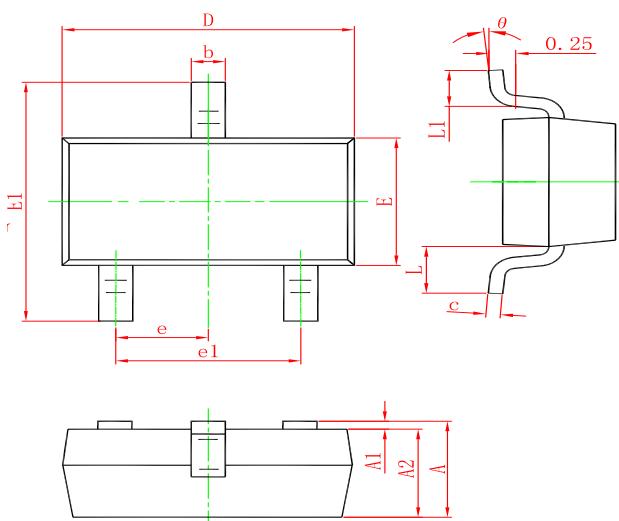


Figure 11. Transient Thermal Response Curve.

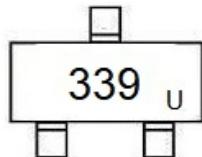
Thermal characterization performed using the conditions described in Note 1b.  
Transient thermal response will change depending on the circuit board design.

## SOT-23 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

## Marking



## Ordering information

Order code	Package	Baseqty	Deliverymode
UMW FDN339AN	SOT-23	3000	Tape and reel

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